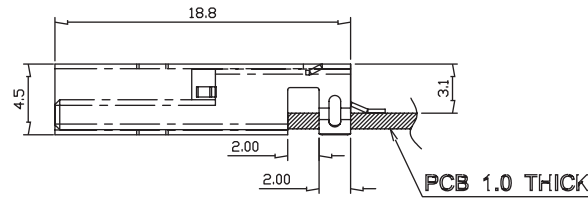
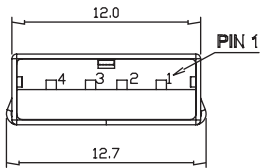


**SUGGESTED PCB LAYOUT
TOP VIEW**



Specifications

- Housing:** Nylon PA9T glass filled
- Shell:** Brass with nickel plating
- Contact:** Phosphor bronze with gold/tin plating
- Plating:** 30u" gold

Peak reflow temperature time and duration =
260 degree C +/- 5 degree C for 3 +/- 0.5 seconds

Ordering Information

AJP13G	4	4	1	3	0	0	X
Type	Positions	Contacts	Ports	Plating 3 = 30u"	Insert 1 = Black 2 = White		

Revision 1

<p>Tolerance unless otherwise specified</p> <p>.0 ± 0.3 .00 ± 0.20 .000 ± 0.075</p>

RIA CONNECT	P/N: AJP13G4413-00X
Desc.: USB 2.0, horizontal edge mount, SMT	
Date: 9-11-06	Drawn By: Donna Mears
Dimensions in mm	Verified By: Mike Balekdjian